503161761 02/02/2015

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHING-WEN HUNG	01/26/2015
CHIH-SEN HUANG	01/26/2015
YI-WEI CHEN	01/26/2015

RECEIVING PARTY DATA

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State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14611843

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	JCLA54539
NAME OF SUBMITTER:	JIAWEI HUANG
SIGNATURE:	/JIAWEI HUANG/
DATE SIGNED:	02/02/2015
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 3

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PATENT 503161761 REEL: 034867 FRAME: 0584

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

☑ Declaration Submitted With Initial Filing				
OR				
Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)				
(Title of the Invention) SEMICONDUCTOR DEVICE STRUCTURE				
As a below named inventor (hereinafter designated as the undersigned), I hereby				
declare that:				
This declaration is directed to:				
∑ The attached application,				
OR ·				
United States Application Number or PCT International application number				
Filed on				
The above-identified application was made or authorized to be made by me.				
I believe I am the original inventor or an original joint inventor of a claimed invention in the application.				

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS 1. United Microelectronics Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

PATENT REEL: 034867 FRAME: 0586

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Ching-Weh Hung Date: JAN 2 6 2015
Legal Name of Sole or First Inventor: Ching-Wen Hung
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Signature: JAN 2 6 2015
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